



P.C.B. LAYOUT
TOP VIEW ±0.05

Circuit	Dimension			Circuit	Dimension		
	A	B	C		A	B	C
04	8.64	3.81	1.27	38	30.23	25.40	22.86
06	9.91	5.08	2.54	40	31.50	26.67	24.13
08	11.18	6.35	3.81	42	32.77	27.94	25.40
10	12.45	7.62	5.08	44	34.04	29.21	26.67
12	13.72	8.89	6.35	46	35.31	30.48	27.94
14	14.99	10.16	7.62	48	36.58	31.75	29.21
16	16.26	11.43	8.89	50	37.85	33.02	30.48
18	17.53	12.70	10.16	52	39.12	34.29	31.75
20	18.80	13.97	11.43	54	40.39	35.56	33.02
22	20.07	15.24	12.70	56	41.66	36.83	34.29
24	21.34	16.51	13.97	58	42.93	38.10	35.56
26	22.61	17.78	15.24	60	44.20	39.37	36.83
28	23.88	19.05	16.51	80	56.90	52.07	49.53
30	25.15	20.32	17.78	100	69.60	64.77	62.23
32	26.42	21.59	19.05	120	82.30	77.47	74.93
34	27.69	22.86	20.32	182	121.67	116.84	114.30
36	28.96	24.13	21.59				

TABLE 1

MATERIALS

HOUSING: THERMOPLASTIC (UL 94V-0)
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
 TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 1 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 30m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -55°C~+105°C

PART NUMBER:

4CEDD - * * * T - 1 1 *

SERIES ————
 NO. OF POS. REF. TABLE 1 ————
 CONTACT PLATED OPTION ————
 1: GOLD FLASH
 3: 3u" GOLD
 5: 5u" GOLD
 6: 10u" GOLD

HOUSING COLOR OPTION
 BLANK: BLACK
 W: WHITE
 BR: BROWN

TRAY PACKAGE
 TIN PLATING ON SOLDER TAIL

Cyberconn Technology Co., Ltd.
 www.cyberconn.com.tw Tel:+886-3-4951314

TOLERANCES	TITLE CARD EDGE, 1.27mm PITCH, PCB MOUNT, SMT FEMALE, WITH POST	CARD EDGE CONNECTOR SERIES				
X.X ±0.3 X.XX ±0.2 X.XXX ±0.1 Angle ±5°		DRAWN BY <i>Janice</i>	CHECKED BY <i>Lion</i>	APPROVED BY <i>Benson</i>		
	UNIT	SCALE	SIZE	DRAW NO.	REV.	Sheet
	10033	MM	NONE	A4	4CEDD-002	A

A	RELEASE	2011.10.18
REV.	DESCRIPTION	DATE